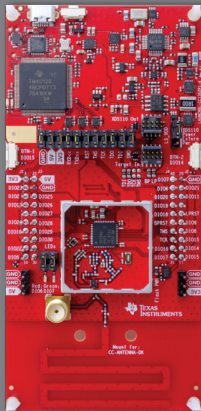




TI LaunchPad™ kit with SimpleLink™ Wireless MCU

Microcontroller development kit for rapid prototyping
featuring the CC1352P microcontroller

PART NO: LAUNCHXL-CC1352P-2



LAUNCH
YOUR DESIGN

START @

Dev.ti.com/launchxl-cc1352p-2

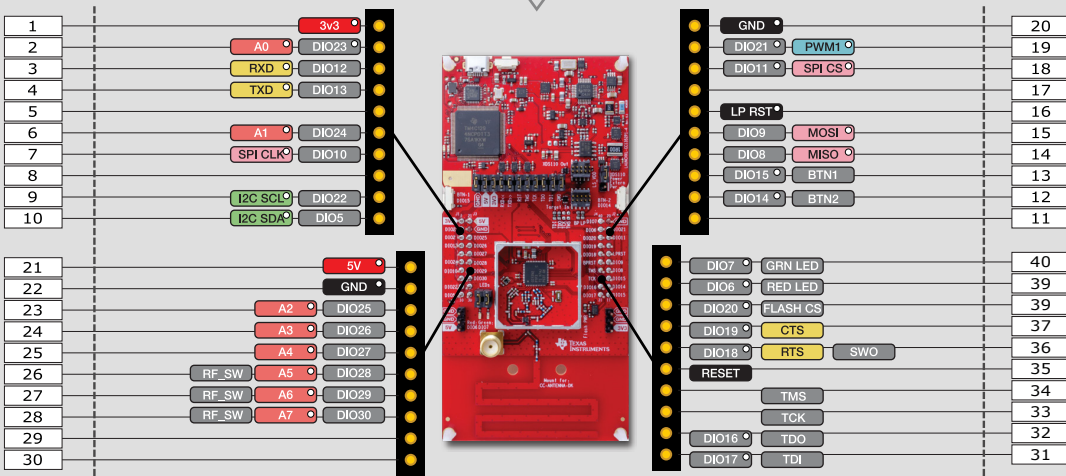


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○ Pin aligns with LaunchPad pinout standard.



Explore all TI LaunchPad™ kits @ www.ti.com/launchpad

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